74LVC162373A; 74LVCH162373A

16-bit D-type transparent latch; 30 Ω series termination resistors; 5 V tolerant inputs/outputs; 3-state

Rev. 6 — 16 September 2021

Product data sheet

1. General description

The 74LVC162373A and 74LVCH162373A are 16-bit D-type transparent latches with 30 Ω termination resistors and 3-state outputs. The 74LVCH162373A has separate D-type inputs with bus hold for each latch. Both devices can be used as two 8-bit transparent latches or a single 16-bit transparent latch. Both devices feature two latch enables (1LE and 2LE) and two output enables ($1\overline{OE}$ and $2\overline{OE}$), each controlling 8-bits. When nLE is HIGH, data at the inputs enter the latches. In this condition the latches are transparent, a latch output will change each time its corresponding D-input changes. When nLE is LOW the latches store the information that was present at the inputs a set-up time preceding the HIGH-to-LOW transition of nLE. A HIGH on $n\overline{OE}$ causes the outputs to assume a high-impedance OFF-state. Operation of the $n\overline{OE}$ input does not affect the state of the latches. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

These devices are fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the devices when they are powered down.

2. Features and benefits

- Overvoltage tolerant inputs to 5.5 V
- Wide supply voltage range from 1.2 V to 3.6 V
- · CMOS low power consumption
- Multibyte flow-through standard pinout architecture
- Multiple low inductance supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold (74LVCH162373A only)
- I_{OFF} circuitry provides partial Power-down mode operation
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

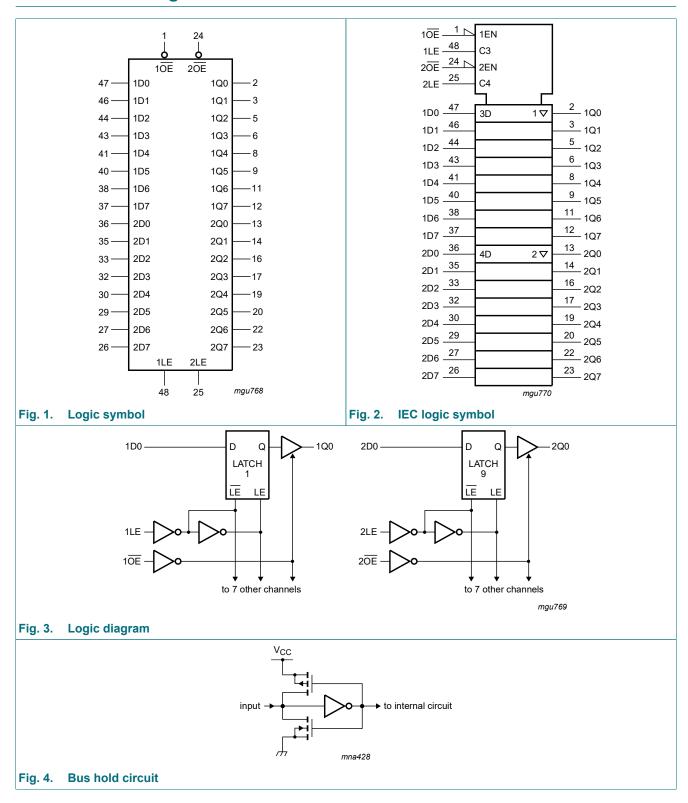
3. Ordering information

Table 1. Ordering information

Type number	Package	ackage					
	Temperature range	Name	Description	Version			
74LVC162373ADGG	-40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1			
74LVCH162373ADGG			48 leads; body width 6.1 mm				

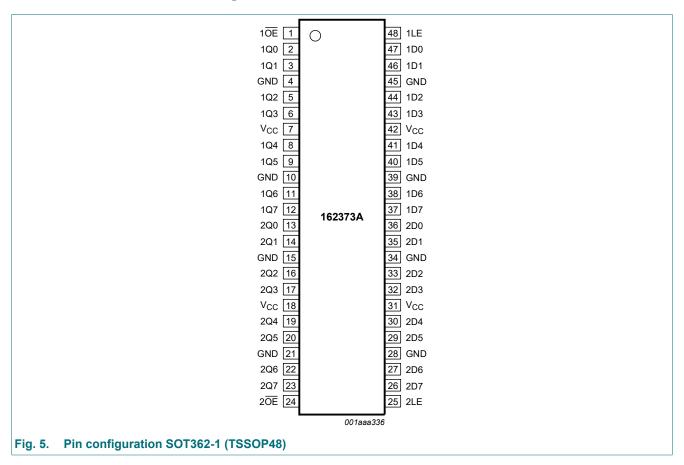


4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1 OE , 2 OE	1, 24	output enable input (active LOW)
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1LE, 2LE	48, 25	latch enable input (active HIGH)
1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7	47, 46, 44, 43, 41, 40, 38, 37	data input
2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7	36, 35, 33, 32, 30, 29, 27, 26	data input
1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7	2, 3, 5, 6, 8, 9, 11, 12	data output
2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7	13, 14, 16, 17, 19, 20, 22, 23	data output

6. Functional description

Table 3. Functional table (per section of 8 bits)

H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

L = LOW voltage level; I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

Z = high-impedance OFF-state.

Operating modes	Input		Internal Latch	Output nQn	
	nOE	nLE	nDn		
Enable and read register	L	Н	L	L	L
(transparent mode)	L	Н	Н	Н	Н
Latch and read register	L	L	I	L	L
	L	L	h	Н	Н
Latch register and disable outputs	Н	L	I	L	Z
	Н	L	h	Н	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$		-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2]	-0.5	V _{CC} + 0.5	V
		output 3-state	[2]	-0.5	+6.5	V
Io	output current	V _O = 0 V to V _{CC}		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[3]	-	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SOT362-1 (TSSOP48) packages: P_{tot} derates linearly with 12.2 mW/K above 109 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level input	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	-	-	0.65 × V _{CC}	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35 × V _{CC}	-	0.35 × V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	I _O = -100 μA; V _{CC} = 1.65 V to 3.6 V	V _{CC} - 0.2	V _{CC}	-	V _{CC} - 0.3	-	V
		$I_O = -2 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		I_{O} = -4 mA; V_{CC} = 2.3 V	1.7	-	-	1.55	-	V
		$I_O = -6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		I_{O} = -12 mA; V_{CC} = 3.0 V	2.2	-	-	2.0	-	V
V _{OL}	LOW-level output	V _I = V _{IH} or V _{IL}						
	voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		I _O = 2 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	V
		I _O = 4 mA; V _{CC} = 2.3 V	-	-	0.6	-	0.8	V
		$I_O = 6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		I_{O} = 12 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V
I _I	input leakage current	V _{CC} = 3.6 V; V _I = 5.5 V or GND [2]	-	±0.1	±5	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; V_O = 5.5 \text{ V or GND [2]}$	-	0.1	±5	-	±20	μΑ

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	20	-	80	μA
ΔI _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$	-	5	500	-	5000	μА
C _I	input capacitance	V_{CC} = 0 V to 3.6 V; V _I = GND to V_{CC}	-	5.0	-	-	-	pF
I _{BHL}	bus hold LOW	V _{CC} = 1.65; V _I = 0.58 V [3][4]	10	-	-	10	-	μA
	current	V _{CC} = 2.3; V _I = 0.7 V	30	-	-	25	-	μA
		V _{CC} = 3.0; V _I = 0.8 V	75	-	-	60	-	μA
I _{BHH}	bus hold HIGH	V _{CC} = 1.65; V _I = 1.07 V [3][4]	-10	-	-	-10	-	μA
	current	V _{CC} = 2.3; V _I = 1.7 V	-30	-	-	-25	-	μA
		V _{CC} = 3.0; V _I = 2.0 V	-75	-	-	-60	-	μA
I _{BHLO}	bus hold LOW	V _{CC} = 1.95 V [3][5]	200	-	-	200	-	μA
	overdrive current	V _{CC} = 2.7 V	300	-	-	300	-	μA
		V _{CC} = 3.6 V	500	-	-	500	-	μA
Івнно	bus hold HIGH	V _{CC} = 1.95 V [3][5]	-200	-	-	-200	-	μΑ
	overdrive current	V _{CC} = 2.7 V	-300	-	-	-300	-	μΑ
		V _{CC} = 3.6 V	-500	-	-	-500	-	μΑ

- [1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.
- The bus hold circuit is switched off when $V_1 > V_{CC}$ allowing 5.5 V on the input pin.
- [3] Valid for data inputs (74LVCH162373A) only; control inputs do not have a bus hold circuit.
- [4] The specified sustaining current at the data inputs holds the input below the specified V_I level.
- [5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 10.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nDn to nQn; see Fig. 6 [2]						
		V _{CC} = 1.2 V	-	12	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	6.6	15.0	1.5	17.2	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	3.5	7.4	1.0	8.5	ns
		V _{CC} = 2.7 V	1.5	3.5	6.7	1.5	8.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	3.0	5.9	1.0	7.5	ns
		nLE to nQn; see Fig. 7						
		V _{CC} = 1.2 V	-	14	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	2.4	7.6	16.0	2.4	18.5	ns
	V _{CC} = 2.3 V to 2.7 V	1.7	4.0	7.9	1.7	9.1	ns	
		V _{CC} = 2.7 V	1.5	3.7	7.0	1.5	9.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.5	3.4	6.1	1.5	8.0	ns

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t _{en}	enable time	nOE to nQn; see Fig. 8 [2]						
		V _{CC} = 1.2 V	-	18	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.7	7.1	15.6	1.7	17.9	ns
		V _{CC} = 2.3 V to 2.7 V	1.5	4.0	8.2	1.5	9.4	ns
		V _{CC} = 2.7 V	1.5	4.2	7.5	1.5	9.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	3.2	6.1	1.0	8.0	ns
t _{dis}	disable time	nOE to nQn; see Fig. 8 [2]						
		V _{CC} = 1.2 V	-	11	-	-	-	ns
		V _{CC} = 1.65 V	2.5	4.2	8.5	2.5	9.8	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	2.3	4.6	1.0	5.3	ns
		V _{CC} = 2.7 V	1.5	3.2	4.8	1.5	6.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.5	2.9	4.6	1.5	6.0	ns
t _W pulse width	nLE HIGH; see Fig. 7							
		V _{CC} = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		V _{CC} = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		V _{CC} = 2.7 V	3.0	-	-	3.0	-	ns
		V _{CC} = 3.0 V to 3.6 V	3.0	2.0	-	3.0	-	ns
t _{su}	set-up time	nDn to nLE; see Fig. 9						
		V _{CC} = 1.65 V to 1.95 V	3.0	-	-	3.0	-	ns
		V _{CC} = 2.3 V to 2.7 V	2.5	-	-	2.5	-	ns
		V _{CC} = 2.7 V	2.0	-	-	2.0	-	ns
		V _{CC} = 3.0 V to 3.6 V	2.0	1.0	-	2.0	-	ns
t _h	hold time	nDn to nLE; see Fig. 9						
		V _{CC} = 1.65 V to 1.95 V	2.5	-	-	2.5	-	ns
		V _{CC} = 2.3 V to 2.7 V	2.0	-	-	2.0	-	ns
		V _{CC} = 2.7 V	0.9	-	-	0.9	-	ns
		V _{CC} = 3.0 V to 3.6 V	+0.9	-1.0	-	+0.9	-	ns
t _{sk(o)}	output skew time	V _{CC} = 3.0 V to 3.6 V [3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per input; $V_I = GND$ to V_{CC} [4]						
	capacitance	V _{CC} = 1.65 V to 1.95 V	-	10.8	-	-	-	pF
		V _{CC} = 2.3 V to 2.7 V	-	13.0	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V	-	15.0	-	-	-	pF

^[1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{en} is the same as t_{PZL} and t_{PZH} .

t_{dis} is the same as t_{PLZ} and t_{PHZ}.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_I = output load capacitance in pF

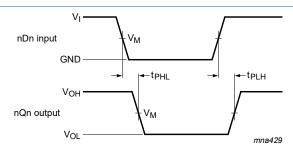
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

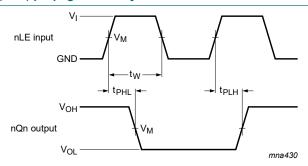
10.1. Waveforms and test circuit



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

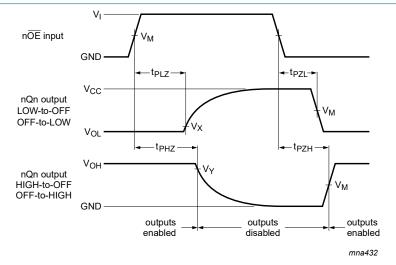
Fig. 6. Input (nDn) to output (nQn) propagation delays



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

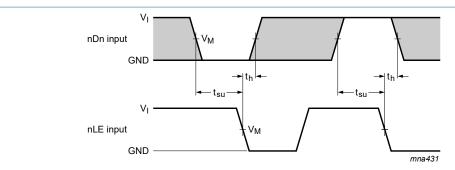
Fig. 7. Latch enable (nLE) pulse width, and the latch enable input to output (nQn) propagation delays



Measurement points are given in <u>Table 8</u>.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 8. 3-state enable and disable times



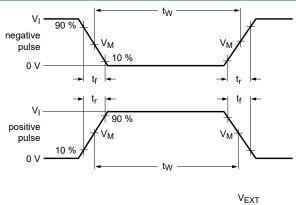
Measurement points are given in <u>Table 8</u>.

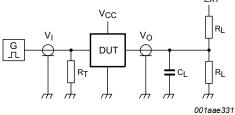
The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 9. Data set-up and hold times for the nDn input to the nLE input

Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{CC}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
1.65 V to 1.95 V	V _{CC}	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
2.3 V to 2.7 V	V _{CC}	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V			





Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig. 10. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load	Load		V _{EXT}		
	V _I	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 x V _{CC}	GND	
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 x V _{CC}	GND	
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	open	2 x V _{CC}	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 x V _{CC}	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 x V _{CC}	GND	

11. Package outline

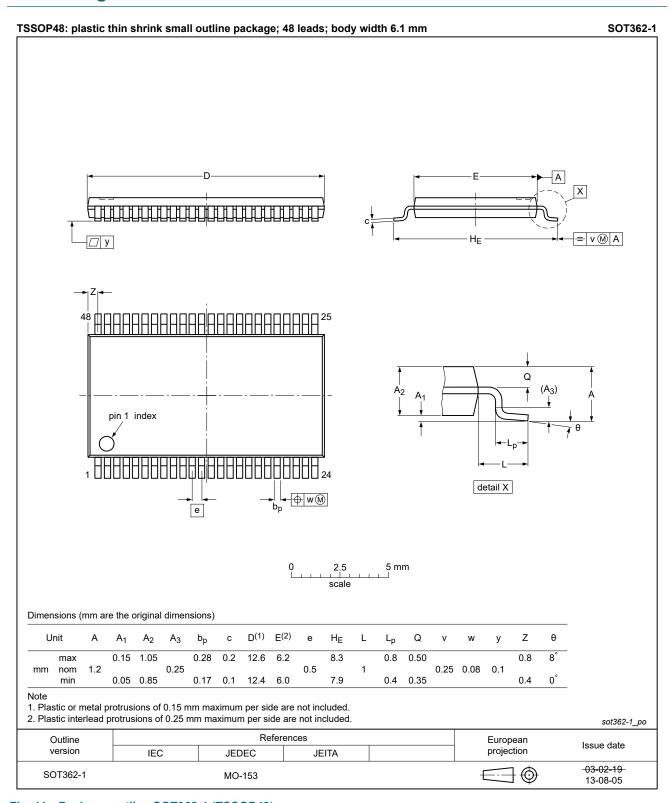


Fig. 11. Package outline SOT362-1 (TSSOP48)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC_LVCH162373A v.6	20210916	Product data sheet	-	74LVC_LVCH162373A v.5	
Modifications:	I	Type number 74LVCH162373ADL (SOT370-1/SSOP48) removed. Section 1 and Section 2 updated.			
74LVC_LVCH162373A v.5	20210414	Product data sheet	-	74LVC_LVCH162373A v.4	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74LVC162373ADL (SOT370-1/SSOP48) removed. Section 7: Derating values for P_{tot} total power dissipation have been updated. Fig. 11: Package outline drawing of SOT362-1/TSSOP48 has changed. 				
74LVC_LVCH162373A v.4	20130514	Product data sheet	-	74LVC_LVCH162373A v.3	
Modifications:	Type numbers: 74LVC162373ADGG and 74LVC162373ADL added.				
74LVC_LVCH162373A v.3	20130118	Product data sheet	-	74LVC_LVCH162373A v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Table 5, Table 6, Table 7, Table 8 and Table 9: values added for lower voltage ranges. 				
74LVC_LVCH162373A v.2	20040205	Product specification	-	74LVC_LVCH162373A v.1	
74LVC_LVCH162373A v.1	19980805	Product specification	-	-	

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

Definitions

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